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ON Semiconductor®

FDD5N50FTM-WS N-Channel UniFETTM FRFET[®] MOSFET **500 V, 3.5 A, 1.55** Ω **Features**

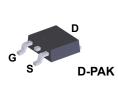
- R_{DS(on)} = 1.25Ω (Typ.) @ V_{GS} = 10 V, I_D = 1.75 A
- Low Gate Charge (Typ. 11 nC)
- Low C_{rss} (Typ. 5 pF)
- · Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- · RoHS Compliant

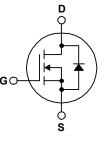
Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is ON Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET® MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

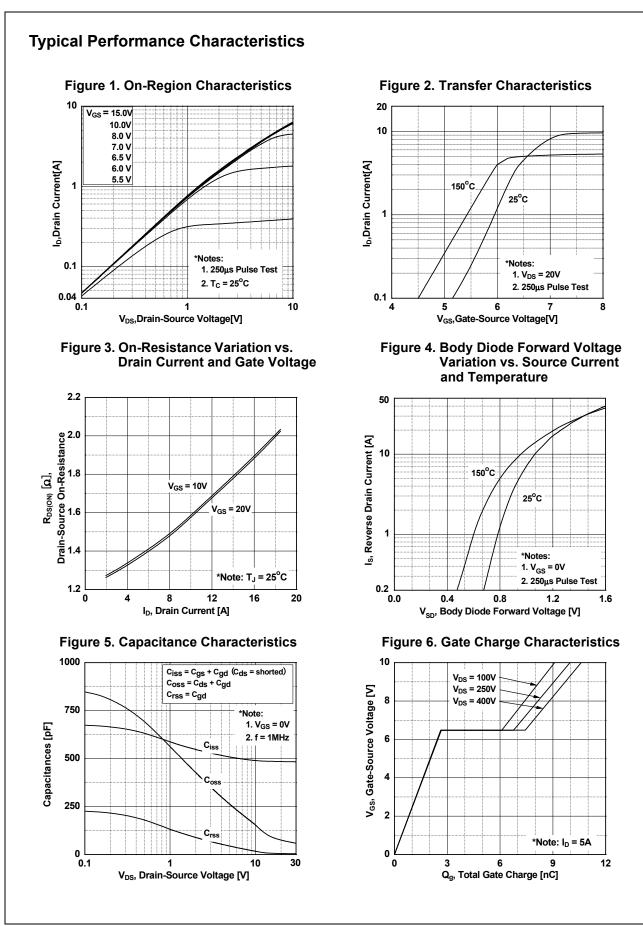
Symbol		Ratings	Units			
V _{DSS}	Drain to Source Voltage	500	V			
V _{GSS}	Gate to Source Voltage			±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		3.5	٨	
		- Continuous (T _C = 100 ^o C)		2.1	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	14	Α	
E _{AS}	Single Pulsed Avalanche E	(Note 2)	257	mJ		
I _{AR}	Avalanche Current	(Note 1)	3.5	Α		
E _{AR}	Repetitive Avalanche Ener	(Note 1)	4	mJ		
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		40	W	
		- Derate Above 25°C		0.3	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

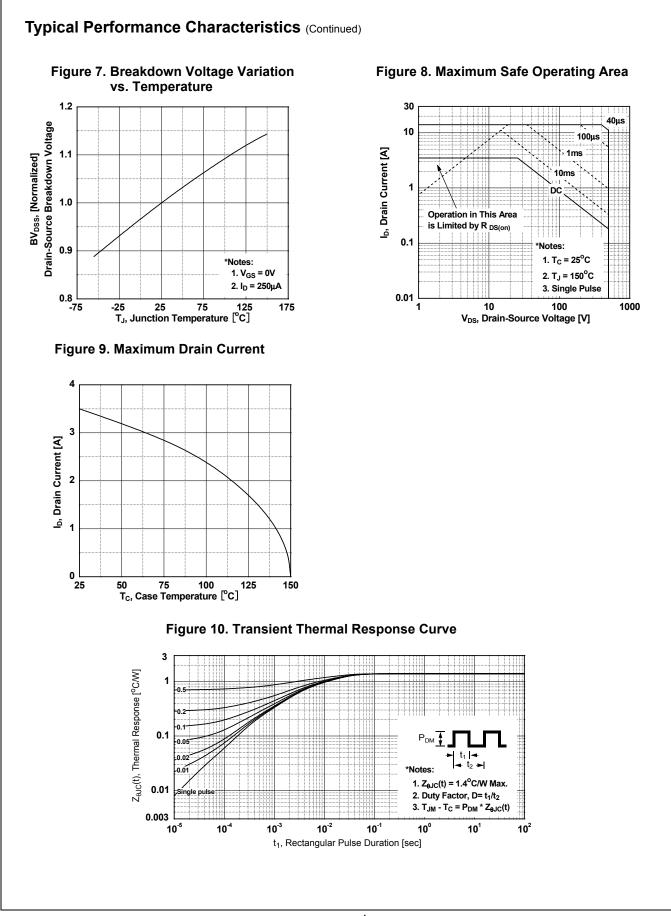
Symbol	Parameter	Ratings	Units		
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.4	°C/W		
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	110	C/W		

	Part Number Top Mark Pa		Package	Packing Method	Reel Size	Tape Width		Qua	ntity
FDD5N50FTM-WS FDD5N50F D-PA		D-PAK	C Tape and Reel 330 mm		16 mm		2500 units		
Electrica	I Chara	icteristics T _C = 25°	C unless oth	nerwise noted.					
Symbol Parameter			Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	cteristics								
BV _{DSS}	Drain to Source Breakdown Voltage		ie Ir	I _D = 250 μA, V _{GS} = 0 V, T _J = 25 ^o C		500	-	-	V
ΔBV_{DSS}	Breakdown Voltage Temperature					000			
ΔT_J		oefficient		I_D = 250 µA, Referenced to 25°C		-	0.6	-	V/ºC
I _{DSS}	Zero Gat	Zero Gate Voltage Drain Current		V _{DS} = 500 V, V _{GS} = 0 V		-	-	10	μA
.022				$V_{DS} = 400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	100	μι
I _{GSS}	Gate to Body Leakage Current		V	V_{GS} = ±30 V, V_{DS} = 0 V		-	-	±100	nA
On Charac	teristics								
V _{GS(th)}	Gate Threshold Voltage		V	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$		3.0	-	5.0	V
R _{DS(on)}		Static Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.75 \text{ A}$			1.25	1.55	Ω
9FS	Forward	Transconductance		$V_{DS} = 20 \text{ V}, I_D = 1.75 \text{ A}$			4.3	-	S
	haracte	ristics	1		1		1		
C _{iss}	Dynamic Characteristics Ciss Input Capacitance					-	490	650	pF
C _{oss}		apacitance		V _{DS} = 25 V, V _{GS} = 0 V	-	-	66	88	pF
C _{rss}		Transfer Capacitance	f	f = 1 MHz		-	5	7.5	pF
Q _{g(tot)}		e Charge at 10V				-	11	15	nC
Q _{gs}		Source Gate Charge	V	/ _{DS} = 400 V, I _D = 5 A,		-	3	-	nC
Q _{gd}		Drain "Miller" Charge	V	V _{GS} = 10 V		_	5	_	nC
		Ū			(Note 4)		0		
Switching	Characte	eristics						I	T
t _{d(on)}	Turn-On	Delay Time			_	-	13	36	ns
t _r	Turn-On	Rise Time		V _{DD} = 250 V, I _D = 5 A R _G = 25 Ω (Note 4)		-	22	54	ns
		Delay Time	r			-	28	66	ns
t _{d(off)}	Turn_Off	Fall Time				-	20	50	ns
t _{d(off)} t _f	Turn-On								
t _f		e Characteristics							
t _f	rce Diod	e Characteristics	urce Diode F	Forward Current		-	-	3.5	Α
t _f Drain-Sou	rce Diod					-	-	3.5 14	A
t _f Drain-Souι I _S Ι _{SM}	rce Diod Maximum Maximum	Continuous Drain to Sou	Diode Forwa			-			
t _f Drain-Sou	rce Diod Maximum Maximum Drain to S	n Continuous Drain to Sou n Pulsed Drain to Source	Diode Forwa Itage V	ard Current			- - - 65	14	Α

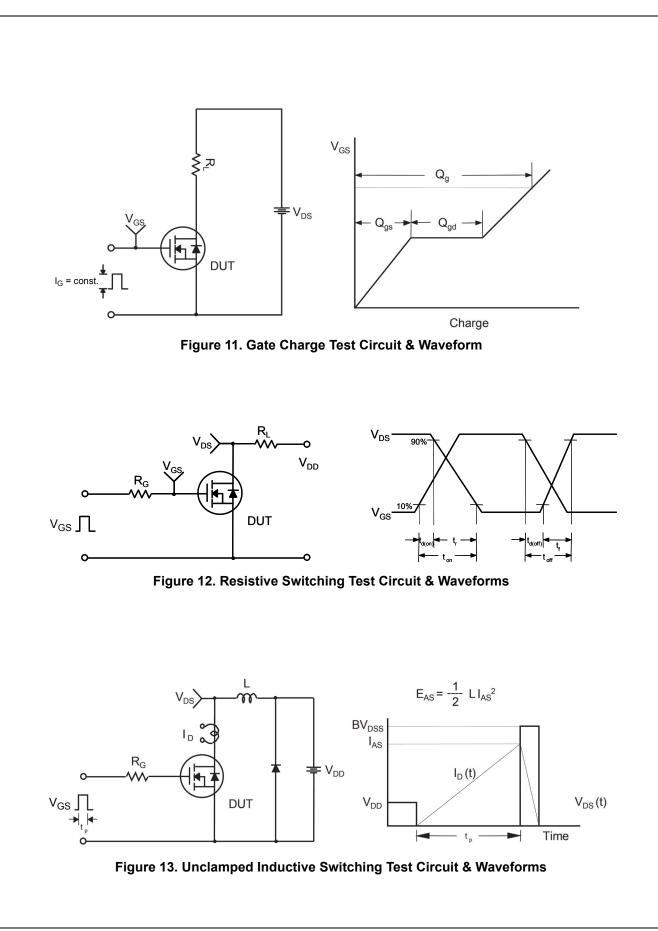


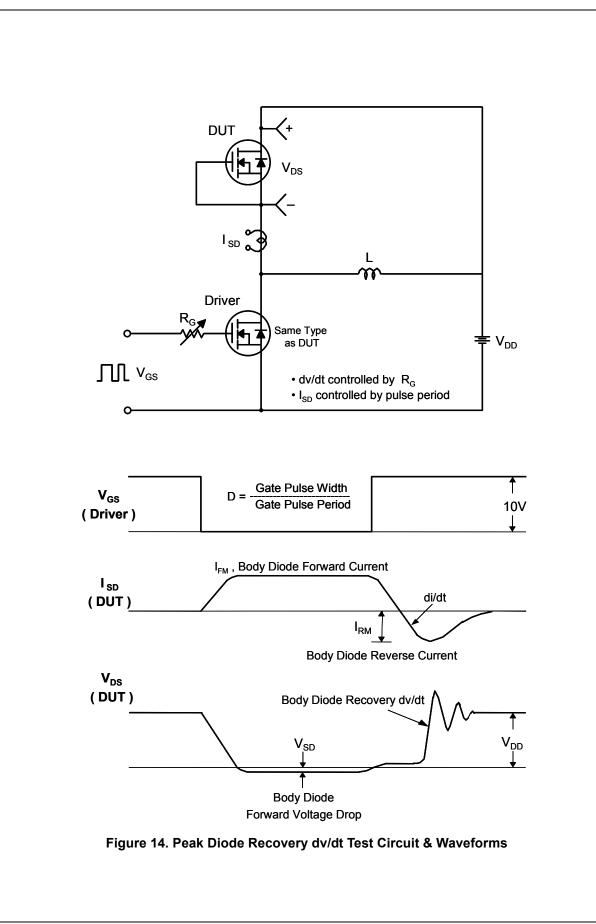


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